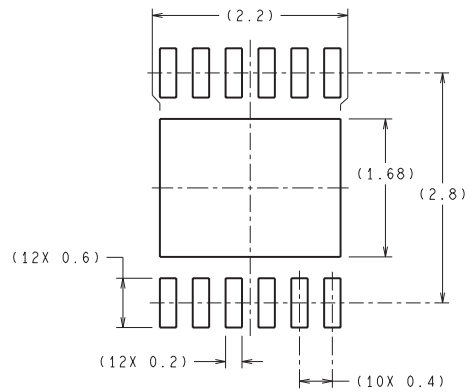
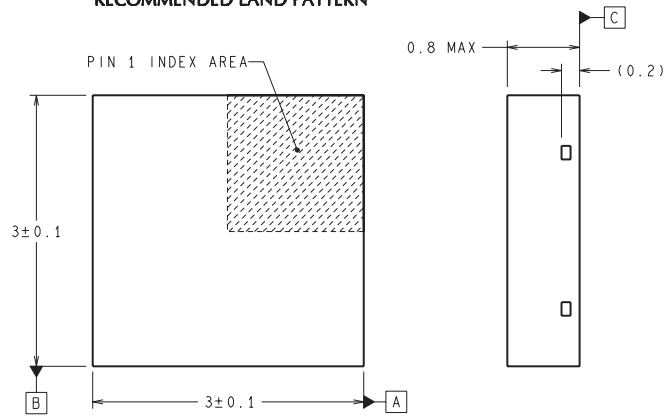
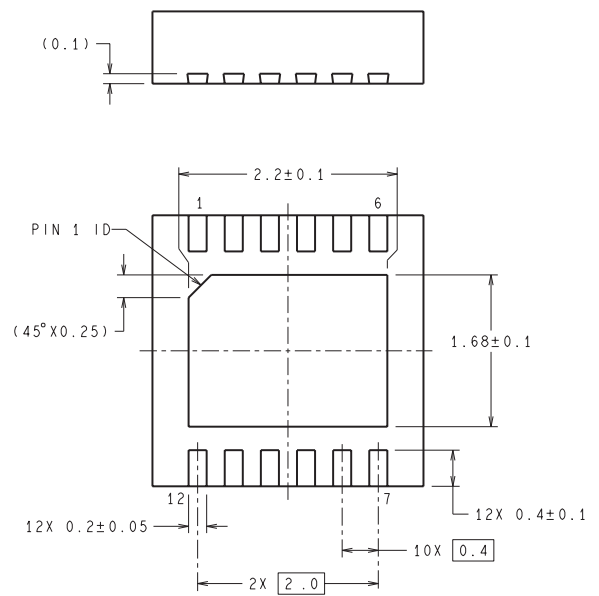


DQB0012A

**RECOMMENDED LAND PATTERN**

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SDF12A (Rev B)

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